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**APPLICATION DATA SHEET**

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**Representative Information:**

R representative Customer Number:	26530
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**Application Information:**

Title:	SEMICONDUCTOR DEVICE HAVING A CARBON FIBER REINFORCED RESIN AS A HEAT RADIATION PLATE HAVING A CONCAVE PORTION
Total Drawing Sheets:	6
Docket:	CU-3569 VE
Application Type:	Utility

**Continuity Information:**

This application is a:	Division of U.S. Serial No. 09/760,396 filed January 12, 2001
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**Prior Foreign Applications:**

Application:	2000-014809
Filing Date:	24 January 2000
Country:	Japan
Priority Claimed:	YES